



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

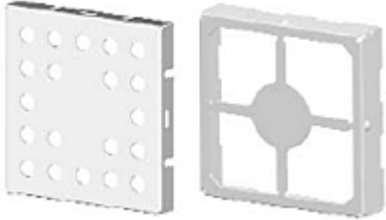
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Laird TechnologiesWeb site: www.LairdTech.com

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Item # BMIS-202 Standard Surface Mount Shields-Two-Piece[larger image](#)

- 48 VQFP
- 44, 48 QFP

Specifications

Surface Area	0.402 inches ²
Surface Area	259.21 mm ²
Maximum Overall Dimension	0.650 x 0.650 inches
Maximum Overall Dimension	16.50 x 16.50 mm
Maximum Overall Height	0.142 inches
Maximum Overall Height	3.60 mm
Material Thickness	0.20 mm
Carrier Tape Width	32 mm
Carrier Tape Pitch	24 mm
Weight	0.5 gms
Pick-up Spot Diameter	≥ 6 mm
Carrier Tape Material	LTIMS-LCB
Cover Tape Material	LTIMS-PSA
Reel Diameter	330 mm
Reel Material	Plastic
Parts Per Reel	700
Material	0.20 mm CRS Tin
Packaging	EIA-481
Co-planarity (Test LTWI-1119 & ANSI/JSTD-002)	< 0.10 mm
Solderability (Test MIL-STD-202 Method 208)	>99 %
Surface Mount Solderability (Test ANSI/EIA 638)	Passes

Appearance (Test LTIES-125)	Passes
Adhesion (Test ASTM B-571)	Passes
3 Axis Mechanical Shock (Test LTES-461)	Passes

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